

C0603X390GATACTU

Aliases (C0603X390GATAC7867)

SMD Comm X8G HT150C Flex, Ceramic, 39 pF, 2%, 250 VDC, X8G, SMD, MLCC, High Temperature, Ultra-Stable, 0603, 0.4 mm



General Information	
Series	SMD Comm X8G HT150C Flex
Style	SMD Chip
Description	SMD, MLCC, High Temperature, Ultra-Stable
Features	High Temperature, Ultra-Stable
RoHS	Yes
Termination	Flexible Termination
Marking	No
AEC-Q200	No
Typical Component Weight	4.6 mg
Shelf Life	78 Weeks
MSL	1

Dimensions	
Chip Size	0603
L	1.6mm +/-0.17mm
W	0.8mm +/-0.15mm
Т	0.8mm +/-0.15mm
S	0.4mm MIN
В	0.45mm +/-0.15mm

Т	0.8mm +/-0.15mm
S	0.4mm MIN
В	0.45mm +/-0.15mm
Packaging Specifications	

4000

Packaging

Packaging Quantity

Specifications		
Capacitance	39 pF	
Measurement Condition	1 MHz 1.0Vrms	
Tolerance	2%	
Voltage DC	250 VDC	
Dielectric Withstanding Voltage	625 VDC	
Temperature Range	-55/+150°C	
Temp. Coefficient	X8G	
Capacitance Change with Reference to +25°C and 0 VDC Applied (TCC)	30 ppm/C, 1MegaHz 1.0Vrms	
Dissipation Factor	0.1% 1 MHz 1.0Vrms	
Aging Rate	0% Loss/Decade Hour: Referee Time is 1000 Hours	
Insulation Resistance	100 GOhms	

Agilig Rate	Time
Insulation Resistance	100 (

T&R, 180mm, Paper Tape

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